# **Triacs**

# **Silicon Bidirectional Thyristors**

Designed primarily for full-wave ac control applications, such as solid-state relays, motor controls, heating controls and power supplies; or wherever full-wave silicon gate controlled solid-state devices are needed. Triac type thyristors switch from a blocking to a conducting state for either polarity of applied anode voltage with positive or negative gate triggering.

- Blocking Voltage to 600 Volts
- All Diffused and Glass Passivated Junctions for Greater Parameter Uniformity and Stability
- Small, Rugged, Thermowatt Construction for Low Thermal Resistance, High Heat Dissipation and Durability
- Gate Triggering Guaranteed in Four Modes
- N Indicates UL Registered File #E69369
- Device Marking: Logo, Device Type, e.g., MAC320A8FP, Date Code

## MAXIMUM RATINGS (T<sub>J</sub> = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit
Peak Repetitive Off–State Voltage <sup>(1)</sup> (T <sub>J</sub> = -40 to +125°C, Sine Wave 50 to 60 Hz, Gate Open)	V <sub>DRM</sub> , V <sub>RRM</sub>	600	Volts
On-State RMS Current ( $T_C = +75$ °C, Full Cycle Sine Wave 50 to 60 Hz) <sup>(2)</sup>	I <sub>T(RMS)</sub>	20	Amps
Peak Non-Repetitive Surge Current (One Full Cycle, 60 Hz, T <sub>C</sub> = +75°C, preceded and followed by rated current)	I <sub>TSM</sub>	150	Amps
Peak Gate Power $(T_C = +75^{\circ}C, \text{ Pulse Width} = 2 \mu\text{s})$	P <sub>GM</sub>	20	Watts
Peak Gate Voltage $(T_C = +75^{\circ}C, \text{ Pulse Width} = 2 \mu\text{s})$	V <sub>GM</sub>	10	Volts
Average Gate Power (T <sub>C</sub> = +75°C, t = 8.3 ms)	P <sub>G(AV)</sub>	0.5	Watt
Peak Gate Current (T <sub>C</sub> = +75°C, Pulse Width = 2 μs)	I <sub>GM</sub>	2.0	Amps
RMS Isolation Voltage (T <sub>A</sub> = 25°C, Relative Humidity ≤ 20%) (%)	V <sub>(ISO)</sub>	1500	Volts
Operating Junction Temperature Range	TJ	-40 to +125	°C
Storage Temperature Range	T <sub>stg</sub>	–40 to +150	°C

- (1) V<sub>DRM</sub> and V<sub>RRM</sub> for all types can be applied on a continuous basis. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.
- (2) The case temperature reference point for all TC measurements is a point on the center lead of the package as close as possible to the plastic body.



## **ON Semiconductor**

http://onsemi.com

# ISOLATED TRIACs (%) 20 AMPERES RMS 600 VOLTS





ISOLATED TO-220 Full Pack CASE 221C STYLE 3

PIN ASSIGNMENT				
1 Main Terminal 1				
2	Main Terminal 2			
3	Gate			

#### **ORDERING INFORMATION**

Device	Package	Shipping	
MAC320A8FP	ISOLATED TO220FP	500/Box	

## THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{ heta JC}$	1.8	°C/W
Thermal Resistance, Case to Sink	$R_{\theta CS}$	2.2	°C/W
Thermal Resistance, Junction to Ambient	$R_{ heta JA}$	60	°C/W
Maximum Lead Temperature for Soldering Purposes 1/8" from Case for 10 Seconds	$T_L$	260	°C

## $\textbf{ELECTRICAL CHARACTERISTICS} \ (T_C = 25^{\circ}\text{C unless otherwise noted}; \ \text{Electricals apply in both directions})$

Characteristic		Symbol	Min	Тур	Max	Unit
Peak Repetitive Blocking Current (V <sub>D</sub> = Rated V <sub>DRM</sub> , V <sub>RRM</sub> ; Gate Open)	$T_J = 25$ °C $T_J = +125$ °C	I <sub>DRM</sub> , I <sub>RRM</sub>		_ _	10 2.0	μ <b>A</b> mA

## **OFF CHARACTERISTICS**

Peak On-State Voltage	$V_{TM}$	1.4	1.7	Volts
$(I_{TM} = \pm 28 \text{ A Peak}; \text{ Pulse Width} = 1 \text{ to 2 ms, Duty Cycle} \leq 2\%)$			0	

## **ON CHARACTERISTICS**

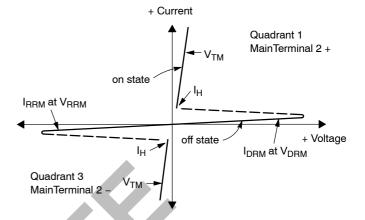
Peak Gate Trigger Current (Main Terminal Voltage = 12 Vdc, R <sub>L</sub> = 100 Ohms) MT2(+), G(+) MT2(+), G(-) MT2(-), G(-) MT2(-), G(+)	lgT	- ON		50 50 50 75	mA
Peak Gate Trigger Voltage (Main Terminal Voltage = 12 Vdc, R <sub>L</sub> = 100 Ohms)  MT2(+), G(+)  MT2(+), G(-)  MT2(-), G(-)  MT2(-), G(+)	V <sub>GT</sub>	02,111	0.9 0.9 1.1 1.4	2.0 2.0 2.0 2.5	Volts
Gate Non–Trigger Voltage (Main Terminal Voltage = 12 V, $R_L = 100 \ \Omega$ , $T_J = +110 ^{\circ} C$ ) All Four Quadrants	V <sub>GD</sub>	0.2	_	_	Volts
Holding Current (Main Terminal Voltage = 12 Vdc, Gate Open, Initiating Current = ±200 mA)	lн	_	6.0	40	mA
Turn-On Time ( $V_D$ = Rated $V_{DRM}$ , $I_{TM}$ = 28 A, $I_{GT}$ = 120 mA, Rise Time = 0.1 $\mu$ s, Pulse Width = 2 $\mu$ s)	t <sub>gt</sub>	_	1.5	10	μs

## DYNAMIC CHARACTERISTICS

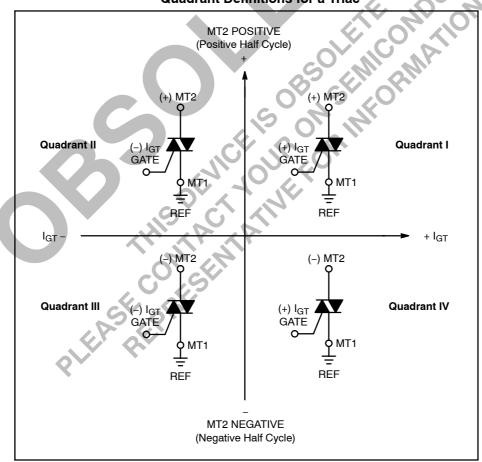
Critical Rate of Rise of Commutation Voltage	dv/dt(c)	_	5.0	_	V/μs
(V <sub>D</sub> = Rated V <sub>DRM</sub> , I <sub>TM</sub> = 28 A, Commutating di/dt = 10 A/ms,					
Gate Unenergized, $T_C = +75^{\circ}C$					

# Voltage Current Characteristic of Triacs (Bidirectional Device)

Symbol	Parameter
V <sub>DRM</sub>	Peak Repetitive Forward Off State Voltage
I <sub>DRM</sub>	Peak Forward Blocking Current
V <sub>RRM</sub>	Peak Repetitive Reverse Off State Voltage
I <sub>RRM</sub>	Peak Reverse Blocking Current
V <sub>TM</sub>	Maximum On State Voltage
I <sub>H</sub>	Holding Current



## **Quadrant Definitions for a Triac**



All polarities are referenced to MT1.

With in-phase signals (using standard AC lines) quadrants I and III are used.

#### **TYPICAL CHARACTERISTICS**

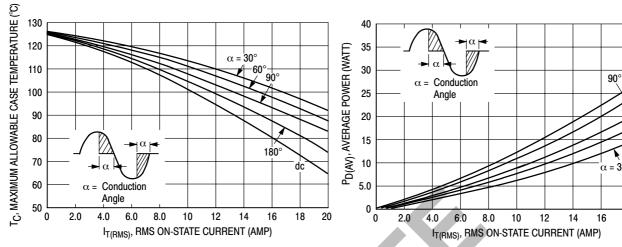


Figure 1. RMS Current Derating

Figure 2. On-State Power Dissipation

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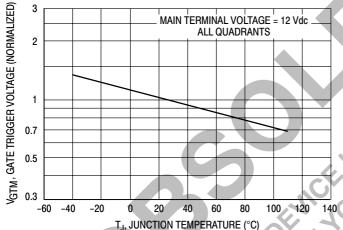


Figure 3. Typical Gate Trigger Voltage

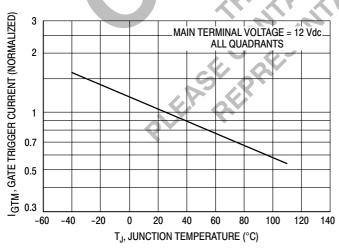


Figure 4. Typical Gate Trigger Current

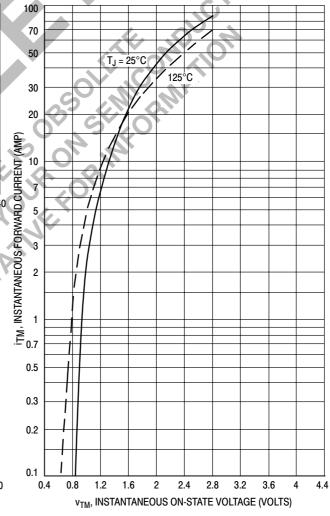


Figure 5. Maximum On-State Characteristics

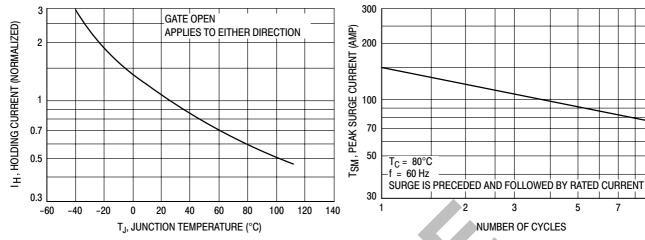
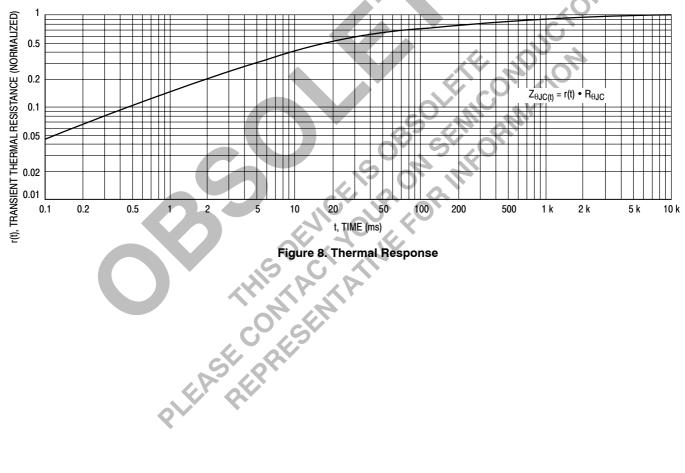


Figure 6. Typical Holding Current

Figure 7. Maximum Nonrepetitive Surge Current

5

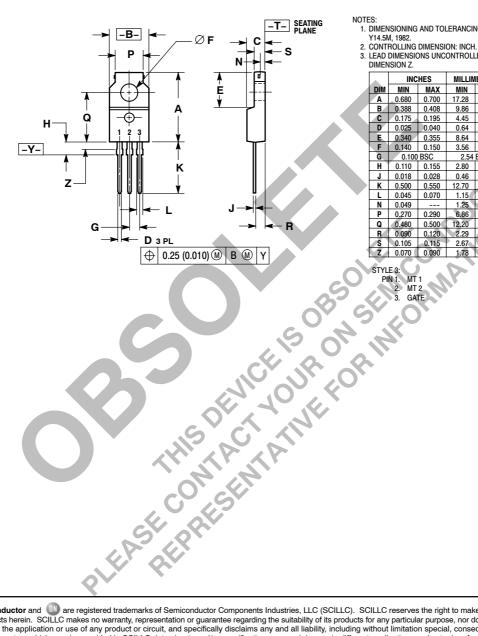
10



#### PACKAGE DIMENSIONS

#### ISOLATED TO-220 Full Pack

CASE 221C-02 **ISSUE C** 



#### NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: INCH.
- 3. LEAD DIMENSIONS UNCONTROLLED WITHIN DIMENSION Z.

	INC	HES	MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	_0.680	0.700	17.28	17.78	
В	0.388	0.408	9.86	10.36	
C	0.175	0.195	4.45	4.95	
D	0.025	0.040	0.64	1.01	
E	0.340	0.355	8.64	9.01	
F	0.140	0.150	3.56	3.81	
G	0.100	BSC	2.54	BSC	
H	0.110	0.155	2.80	3.93	
J	0.018	0.028	0.46	0.71	
K	0.500	0.550	12.70	13.97	
L	0.045	0.070	1.15	1.77	
N	0.049		1.25	<b></b>	
P	0.270	0.290	6.86	7.36	
Q	0.480	0.500	12.20	12.70	
R	0.090	0.120	2.29	3.04	
S	0.105	0.115	2.67	2.92	
Z	0.070	0.090	1.78	2.28	

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